1W Surface Mount Zener Diode

Features

- For surface mounted applications in order to optimize board space
- Low profile space
- Low Zener impedance
- High reliability
- For use in stabilizing and clipping circuits with high power rating.
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

Mechanical Date

- Case: Flat Lead SOD-123 Small Outline Plastic Package
- **Polarity:** Types the band by laser denotes the cathode
- Terminals:Solder plated, solderable per MIL-STD-750 Method 2026 Weight:0.0007 ounce, 0.02 grams

Applications

• For general purpose regulation and protection applications

Maximum Ratings & Thermal Characteristics

(T _A = 25 °C unless otherwise noted)	
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	Symbol	VALUE	UNIT
power dissipation	P _{tot}	1	W
Thermal resistance from junction to ambient ⁽¹⁾	R _{θJA}	230	°C/W
Operating junction temperature range	TJ	–65 to +150	°C
Storage temperature range	T _{STG}	-65 to +150	°C

These ratings are limiting values above which the serviceability of the diode may be impaired.

Note1: Mounted on FR-4 P.C.B. With 0.9x1.5 mm copper pad areas (\approx 35 µm thick)

Electrical Characteristics

 T_A =25 $^\circ\!\mathrm{C}$ unless otherwise noted.

TYPE	Zener Voltage				Zener Impedance Leakage Current				I	
		V _Z (Volts) @I _{ZT}		Z _{ZT} @I _{ZT}	Z _{zκ} @l _{zκ}		I _R @V _R		^I ZM	
	Min	Nom	Мах	mA	Ω	Ω	mA	uA	Volts	mA
1DZ120	114	120	126	2.0	550	4500	0.25	5	91.2	7.8



Dimensions in millimeters



Fig. 1 - Maximum Continuous Power Dissipation



40

0.01

0

20

T_J = 25 C

80

100

60

Percent of Rated Zener Voltage (%)

